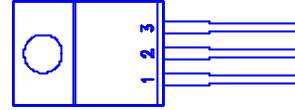
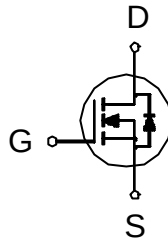


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
25	5m Ω	75A



1. GATE
2. DRAIN
3. SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_C = 25\text{ }^{\circ}\text{C}$	I_D	75	A
	$T_C = 100\text{ }^{\circ}\text{C}$		50	
Pulsed Drain Current ¹		I_{DM}	170	
Avalanche Current		I_{AR}	60	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	140	mJ
Repetitive Avalanche Energy ²	$L = 0.05\text{mH}$	E_{AR}	5.6	
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	P_D	60	W
	$T_C = 100\text{ }^{\circ}\text{C}$		32.75	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^{\circ}\text{C}$
Lead Temperature (l_{16} " from case for 10 sec.)		T_L	275	

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.3	$^{\circ}\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		62.5	
Case-to-Heatsink	$R_{\theta CS}$	0.6		

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

ELECTRICAL CHARACTERISTICS ($T_C = 25\text{ }^{\circ}\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	25			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.5	3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 250	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$			25	μA
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 125\text{ }^{\circ}C$			250	

On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 10V, V _{GS} = 10V	70			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 30A		5	7	mΩ
		V _{GS} = 7V, I _D = 24A		6	8	
Forward Transconductance ¹	g _{fs}	V _{DS} = 15V, I _D = 30A		16		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		5000		pF
Output Capacitance	C _{oss}			1800		
Reverse Transfer Capacitance	C _{rss}			800		
Total Gate Charge ²	Q _g	V _{DS} = 0.5V _{(BR)DSS} , V _{GS} = 10V, I _D = 35A		140		nC
Gate-Source Charge ²	Q _{gs}			40		
Gate-Drain Charge ²	Q _{gd}			75		
Turn-On Delay Time ²	t _{d(on)}	V _{DS} = 15V, R _L = 1Ω I _D ≅ 30A, V _{GS} = 10V, R _{GS} = 2.5Ω		7		nS
Rise Time ²	t _r			7		
Turn-Off Delay Time ²	t _{d(off)}			24		
Fall Time ²	t _f			6		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _c = 25 °C)						
Continuous Current	I _S				75	A
Pulsed Current ³	I _{SM}				170	
Forward Voltage ¹	V _{SD}	I _F = I _S , V _{GS} = 0V			1.3	V
Reverse Recovery Time	t _{rr}	I _F = I _S , dI _F /dt = 100A / μS		37		nS
Peak Reverse Recovery Current	I _{RM(REC)}			200		A
Reverse Recovery Charge	Q _{rr}			0.043		μC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

REMARK: THE PRODUCT MARKED WITH "P75N02LTG", DATE CODE or LOT #

Orders for parts with Lead-Free plating can be placed using the PXXXXXXXG parts name

TO-220 (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.78	10.16	10.54	H	2.4	2.54	2.68
B	2.61	2.74	2.87	I	1.19	1.27	1.35
C		20		J	4.4	4.6	4.8
D	28.5	28.9	29.3	K	1.14	1.27	1.4
E	14.6	15.0	15.4	L	2.3	2.6	2.9
F	8.4	8.8	9.2	M	0.26	0.46	0.66
G	0.72	0.8	0.88	N		7°	

